

Nips Diode Modules (Water Cooling) MD600D**W MC600D**W MR600D**W

Features:

- Isolated mounting base 4000V~
- Pressure contact technology with Increased power cycling capability
- Space and weight saving

Typical Applications

- AC/DC Motor drives
- Various rectifiers
- DC supply for PWM inverter

V _{RSM}	V _{RRM}	品名
2700V	2600V	Mx600D260W
2900V	2800V	Mx600D280W
3100V	3000V	Mx600D300W
3300V	3200V	Mx600D320W
3500V	3400V	Mx600D340W
3700V	3600V	Mx600D360W

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _j (°C)	VALUE			UNIT
				Min.	Typ.	Max.	
I _{F(AV)}	Mean forward current	180° half sine wave 50Hz Single side water cooled, T _C =60°C	150			600	A
I _{F(RMS)}	RMS forward current		150			942	A
I _{RRM}	Repetitive peak current	at V _{RRM}	150			45	mA
I _{FSM}	Surge forward current	10ms half sine wave V _R =0.6V _{RRM}	150			10.0	kA
I ² t	I ² t for fusing coordination					500	A ² s*10 ³
V _{FO}	Threshold voltage		150			0.95	V
r _F	Forward slope resistance					0.91	mΩ
V _{FM}	Peak forward voltage	I _{FM} =1800A	25			2.79	V
R _{th(j-c)}	Thermal resistance Junction to case	D.C. Single side cooled per chip				0.065	°C /W
R _{th(c-h)}	Thermal resistance case to heat sink	D.C. Single side cooled per chip				0.024	°C /W
V _{iso}	Isolation voltage	50Hz,R.M.S,t=1min, I _{iso} :1mA(max)		4000			V
F _m	Terminal connection torque(M12)				14.0		N·m
	Mounting torque(M8)				12.0		N·m
T _{stg}	Stored temperature			-40		125	°C
W _t	Weight				3460		g
Outline	M15						

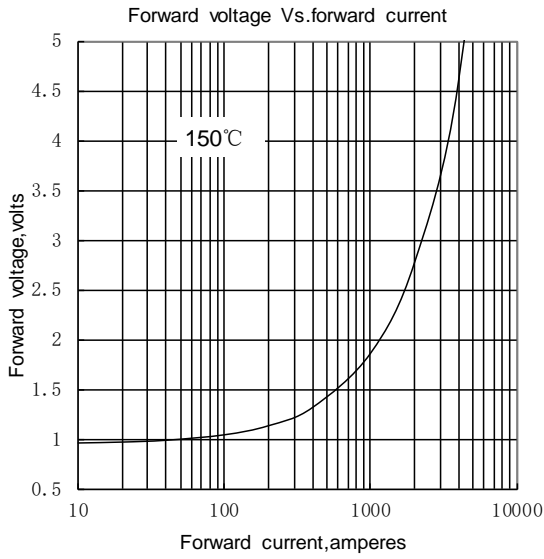


Fig.1

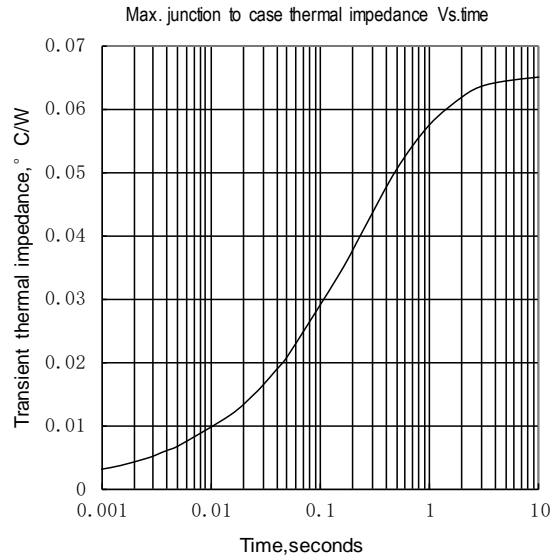


Fig.2

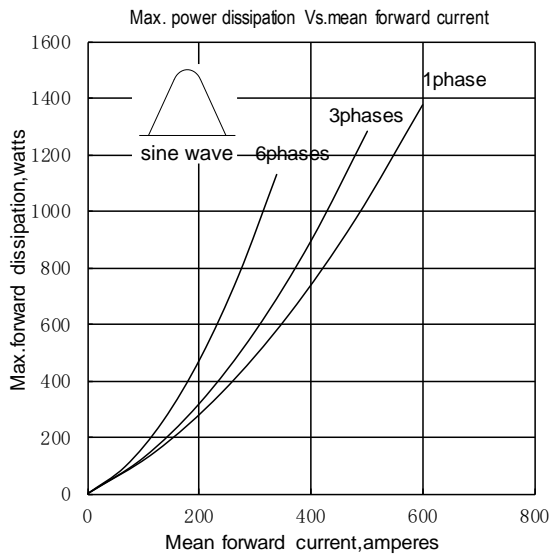


Fig.3

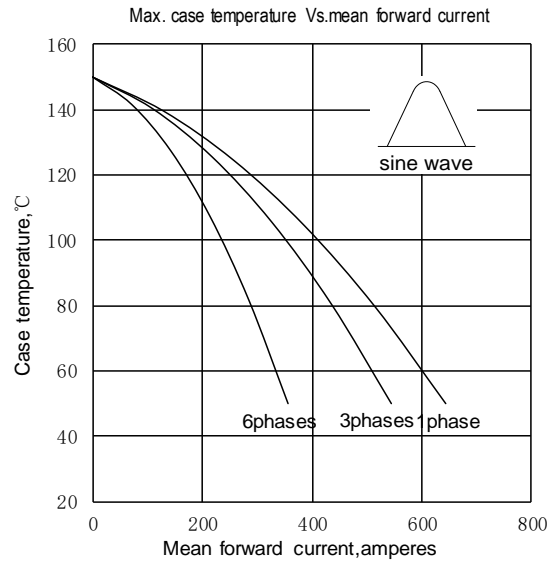


Fig.4

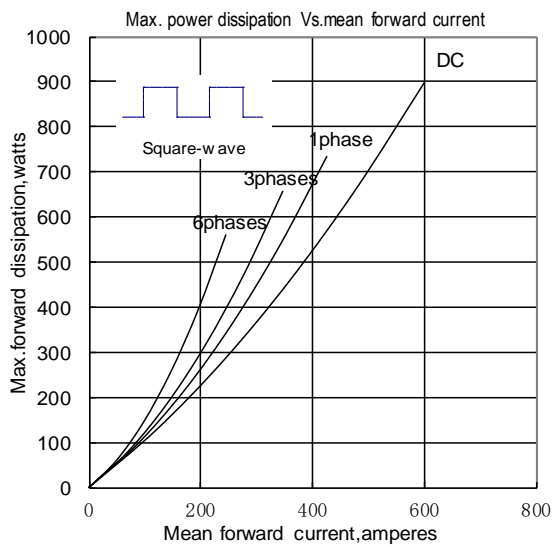


Fig.5

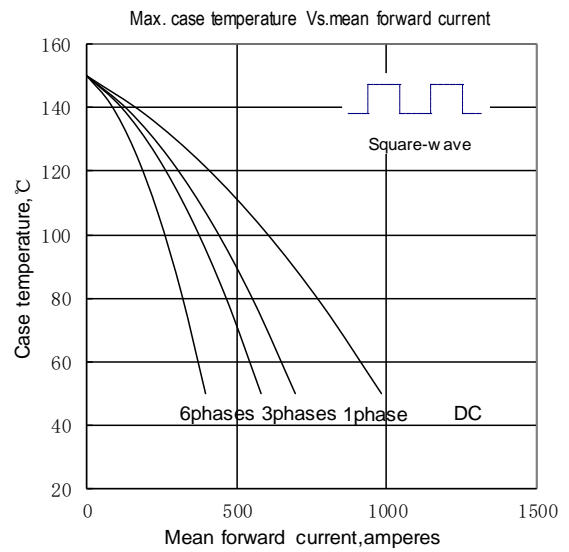


Fig.6

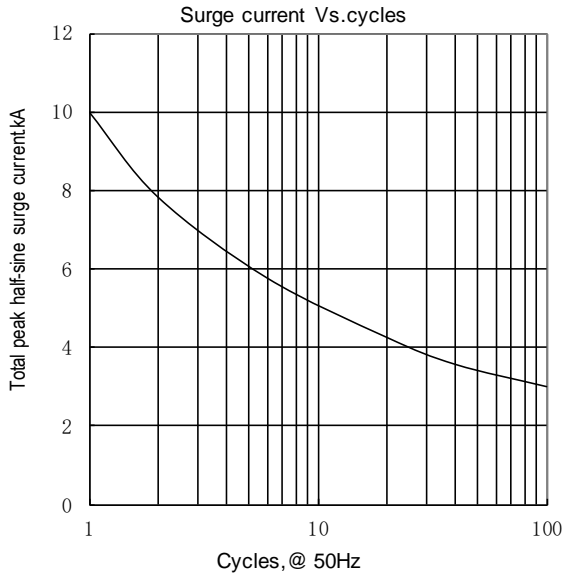
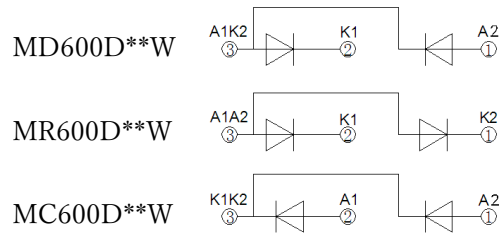
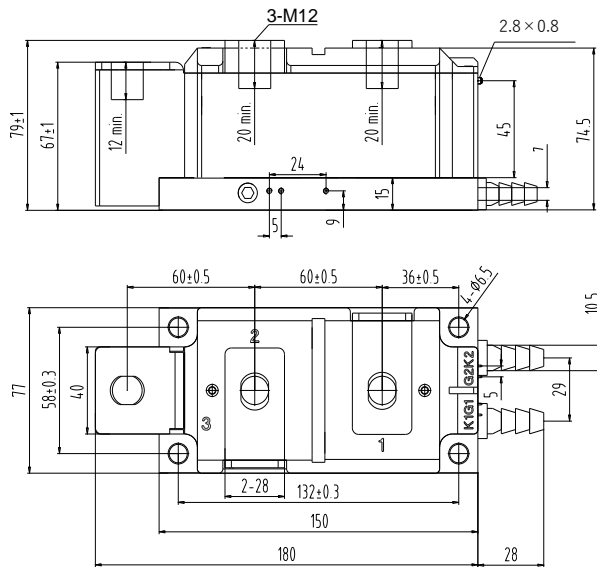


Fig.7



Unmarked dimensional tolerance : ±0.5mm